

# TPC8210

Lithium Ion Battery Applications  
 Portable Equipment Applications  
 Notebook PC Applications

- Low drain-source ON resistance:  $R_{DS(ON)} = 11 \text{ m}\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 13 \text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = 10 \text{ }\mu\text{A}$  (max) ( $V_{DS} = 30 \text{ V}$ )
- Enhancement-mode:  $V_{th} = 1.3 \text{ to } 2.5 \text{ V}$  ( $V_{DS} = 10 \text{ V}$ ,  $I_D = 1 \text{ mA}$ )

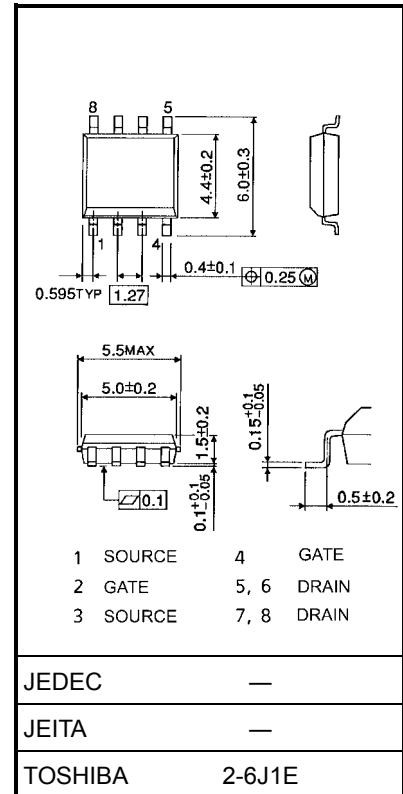
## Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	30	V
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )		$V_{DGR}$	30	V
Gate-source voltage		$V_{GSS}$	$\pm 20$	V
Drain current	D C (Note 1)	$I_D$	8	A
	Pulse (Note 1)	$I_{DP}$	32	
Drain power dissipation ( $t = 10 \text{ s}$ ) (Note 2a)	Single-device operation (Note 3a)	$P_{D(1)}$	1.5	W
	Single-device value at dual operation (Note 3b)	$P_{D(2)}$	1.1	
Drain power dissipation ( $t = 10 \text{ s}$ ) (Note 2b)	Single-device operation (Note 3a)	$P_{D(1)}$	0.75	W
	Single-device value at dual operation (Note 3b)	$P_{D(2)}$	0.45	
Single pulse avalanche energy (Note 4)		$E_{AS}$	83.2	mJ
Avalanche current		$I_{AR}$	8	A
Repetitive avalanche energy Single-device value at dual operation (Note 2a, 3b, 5)		$E_{AR}$	0.1	mJ
Channel temperature		$T_{ch}$	150	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	-55 to 150	$^\circ\text{C}$

Note: For (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5), please refer to the next page.

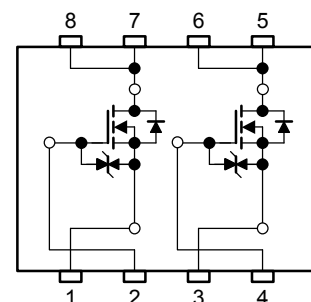
This transistor is an electrostatic sensitive device. Please handle with caution.

Unit: mm



Weight: 0.08 g (typ.)

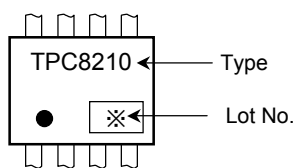
## Circuit Configuration



## Thermal Characteristics

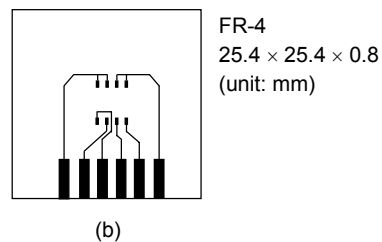
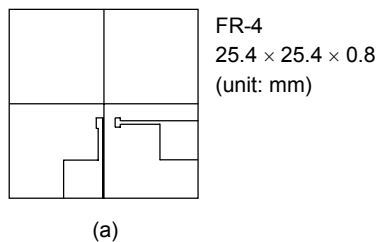
Characteristics		Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s)	Single-device operation (Note 3a)	R <sub>th (ch-a)</sub> (1)	83.3	°C/W
	Single-device value at dual operation (Note 3b)	R <sub>th (ch-a)</sub> (2)	114	
Thermal resistance, channel to ambient (t = 10 s)	Single-device operation (Note 3a)	R <sub>th (ch-a)</sub> (1)	167	
	Single-device value at dual operation (Note 3b)	R <sub>th (ch-a)</sub> (2)	278	

## Marking (Note 6)



Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:



- a) Device mounted on a glass-epoxy board (a)      b) Device mounted on a glass-epoxy board (b)

Note 3:

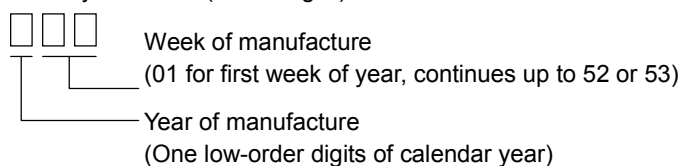
- a) The power dissipation and thermal resistance values are shown for a single device. (During single-device operation, power is only applied to one device.)
- b) The power dissipation and thermal resistance values are shown for a single device. (During dual operation, power is evenly applied to both devices.)

Note 4: V<sub>DD</sub> = 24 V, T<sub>ch</sub> = 25°C (initial), L = 1.0 mH, R<sub>G</sub> = 25 Ω, I<sub>AR</sub> = 8 A

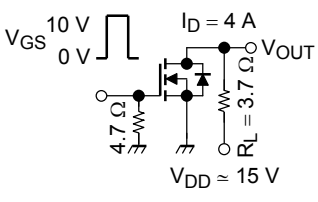
Note 5: Repetitive rating: pulse width limited by maximum channel temperature

Note 6: • on lower left of the marking indicates Pin 1.

※ Weekly code: (Three digits)

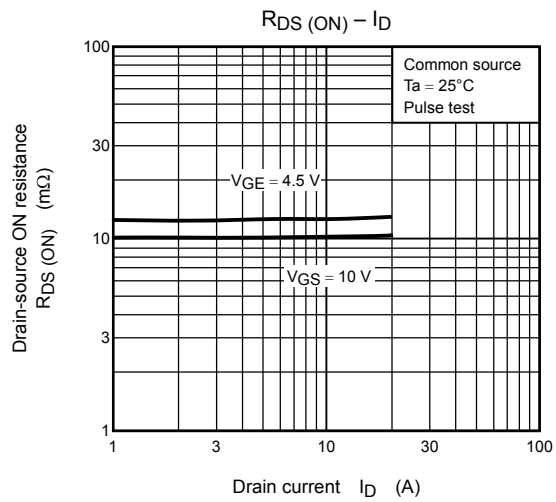
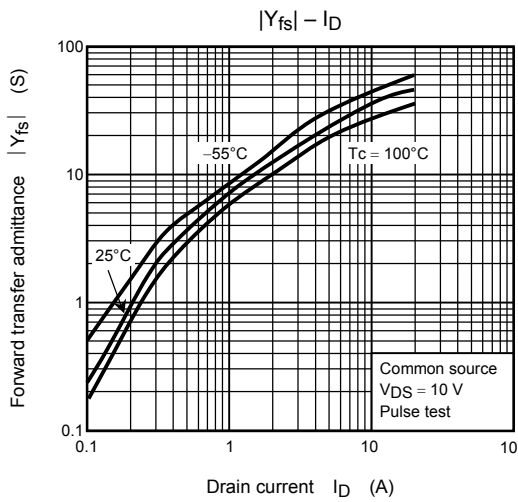
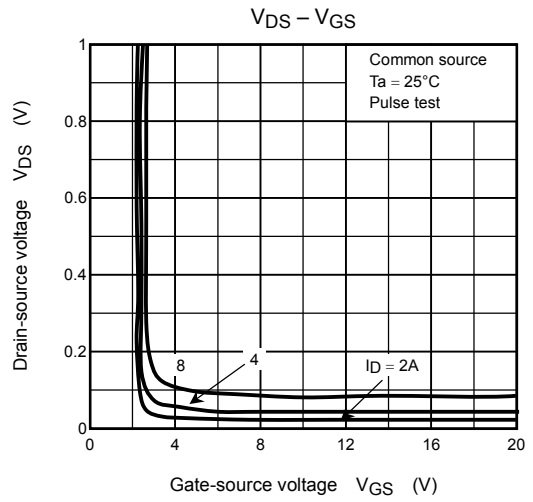
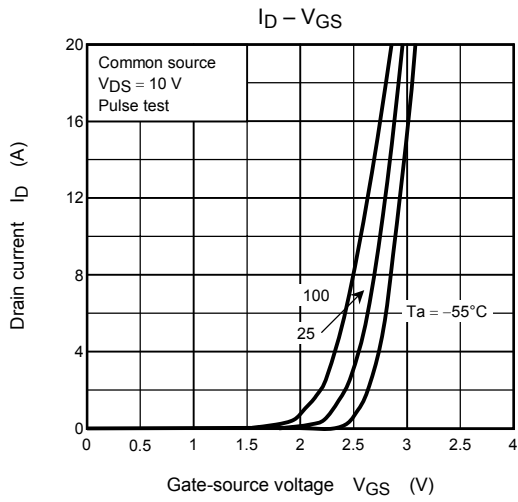
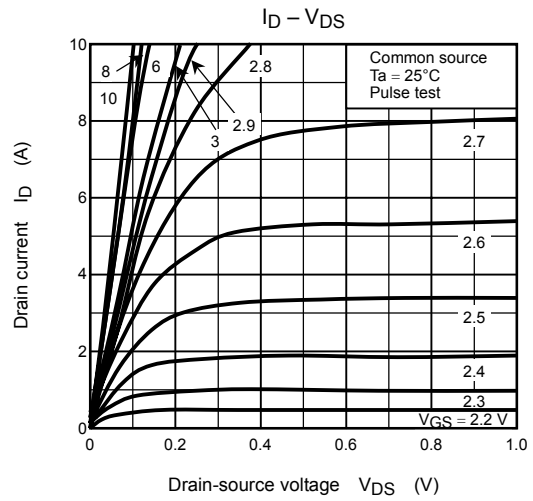
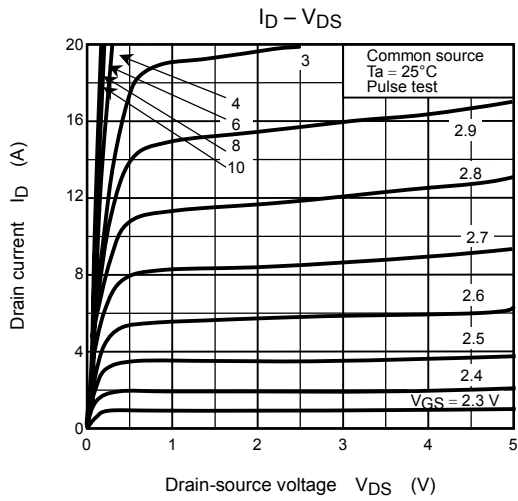


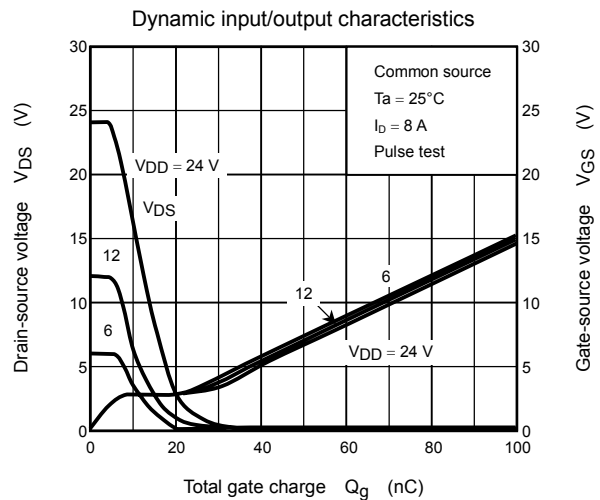
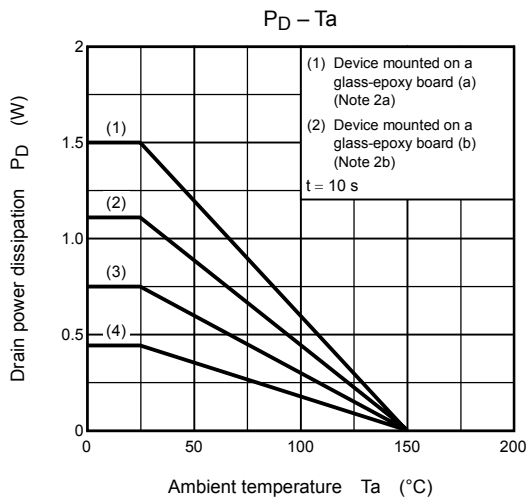
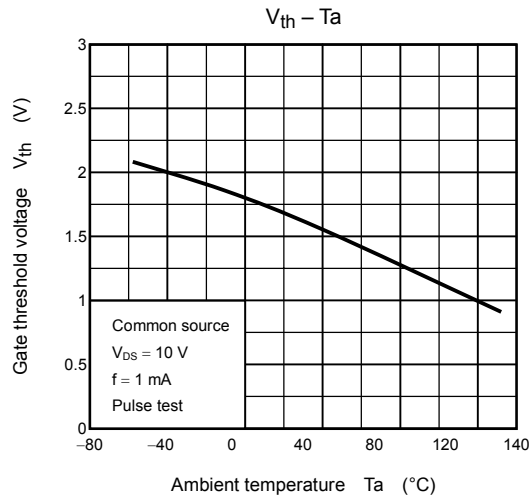
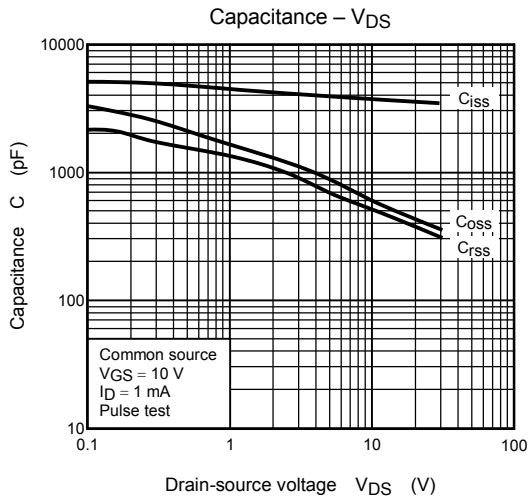
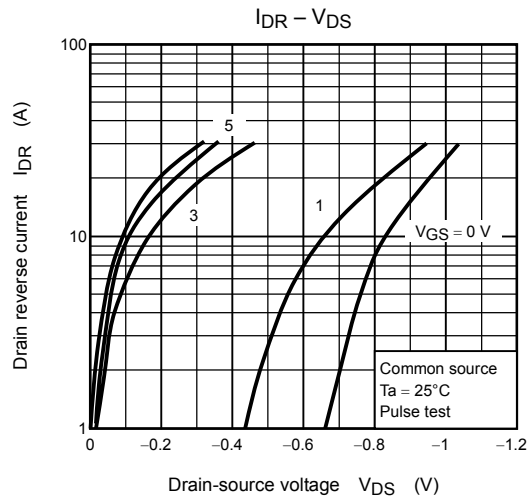
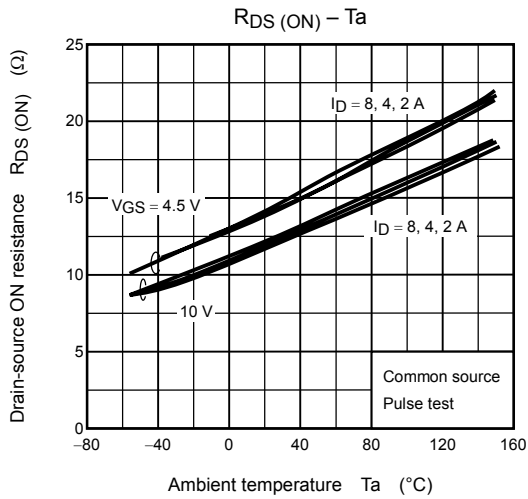
## Electrical Characteristics (Ta = 25°C)

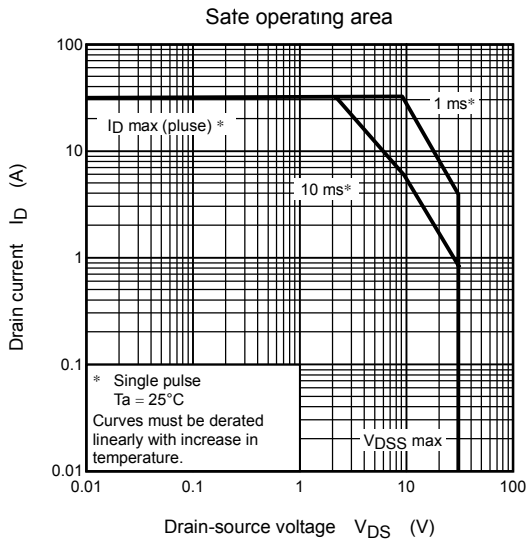
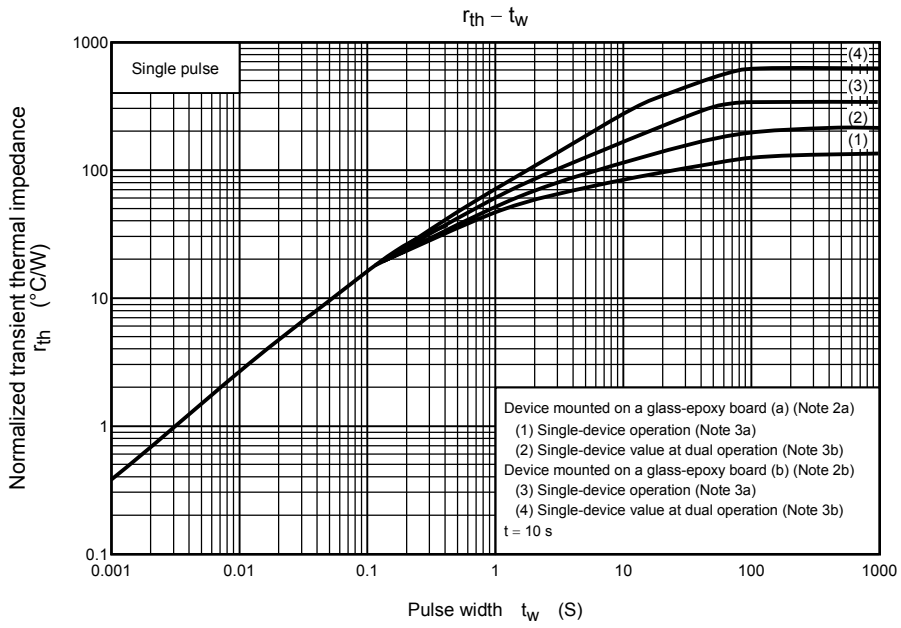
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 16\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Drain cut-OFF current		$I_{DSS}$	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$	—	—	10	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	30	—	—	V
		$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = -20\text{ V}$	15	—	—	
Gate threshold voltage		$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	1.3	—	2.5	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 4.5\text{ V}, I_D = 4\text{ A}$	—	13	20	m $\Omega$
		$R_{DS(ON)}$	$V_{GS} = 10\text{ V}, I_D = 4\text{ A}$	—	11	15	
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 4\text{ A}$	6.5	13	—	S
Input capacitance		$C_{iss}$	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	3530	—	pF
Reverse transfer capacitance		$C_{rss}$		—	495	—	
Output capacitance		$C_{oss}$		—	580	—	
Switching time	Rise time	$t_r$	 <p><math>Duty \leq 1\%, t_w = 10\ \mu\text{s}</math></p>	—	26	—	ns
	Turn-ON time	$t_{on}$		—	39	—	
	Fall time	$t_f$		—	32	—	
	Turn-OFF time	$t_{off}$		—	115	—	
Total gate charge (Gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx 24\text{ V}, V_{GS} = 10\text{ V}, I_D = 8\text{ A}$	—	75	—	nC
Gate-source charge		$Q_{gs}$		—	6	—	
Gate-drain ("miller") charge		$Q_{gd}$		—	19	—	

## Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	$I_{DRP}$	—	—	—	32	A
Forward voltage (diode)		$V_{DSF}$	$I_{DR} = 8\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.2	V







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